

VMMBZ16C1DD1 to VMMBZ33C1DD1

Vishay Semiconductors

AUTOMOTIVE GRADE

RoHS

COMPLIANT

HALOGEN FREE

GREEN

(5-2008)

Single-Line Bidirectional ESD-Protection Diode in DFN1006-2B





MARKING (example only)



Bar = pin 1 marking X = date code YY = type code (see table below)

LINKS TO ADDITIONAL RESOURCES







FEATURES

- Compact DFN1006-2B package
- Low package height < 0.5 mm
- 1-line bidirectional ESD-protection
- AEC-Q101 qualified available
- Working range ±14 V; ± 28 V
- ESD immunity acc. IEC 61000-4-2 ±15 kV to ±30 kV contact discharge ±15 kV to ±30 kV air discharge
- Lead plating: Sn (e3)
- Soldering can be checked by standard vision inspection
- AOI = Automated Optical Inspection
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

Soldering Recommendations for DFN Packages:

please see Application Note: www.vishav.com/doc?86198



ORDERING INFORMATION						
	AEC-Q101 QUALIFIED	ENVIRONMEN				
PART NUMBER (EXAMPLE)		RoHS COMPLIANT + LEAD (Pb)-FREE TERMINATIONS	TIN PLATED	10K PER 7" REEL (8 mm TAPE)	ORDERING CODE (EXAMPLE)	
		GREEN		MOQ = 10K/BOX		
VMMBZ16C1DD1	-	G	3	-08	VMMBZ16C1DD1-G3-08	
VMMBZ16C1DD1	Н	G	3	-08	VMMBZ16C1DD1HG3-08	

PACKAGE DATA								
DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS		
VMMBZ16C1DD1	DFN1006-2B	2Y	0.83 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C		
VMMBZ33C1DD1	DFN1006-2B	2N	0.83 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C		

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ABSOLUTE MAXIMUM RATINGS VMMBZ16C1DD1 (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT		
Peak pulse current	Acc. IEC 61000-4-5, 8/20 μs/single shot	I _{PPM}	4	Α		
Peak pulse power	Acc. IEC 61000-4-5, 8/20 μs/single shot ⁽¹⁾	P _{PP}	108	W		
Peak pulse current	t _p = 10/1000 μs ⁽¹⁾	I _{PPM}	0.65	Α		
Peak pulse power	t _p = 10/1000 μs ⁽¹⁾	P _{PP}	15	W		
ESD immunity	Contact discharge acc. IEC 61000-4-2; 10 pulses (1)	W	30	kV		
	Air discharge acc. IEC 61000-4-2; 10 pulses (1)	V_{ESD}	30	kV		
Operating temperature	Junction temperature	TJ	-55 to +150	°C		
Storage temperature		T _{sta}	-55 to +150	°C		

ABSOLUTE MAXIMUM RATINGS VMMBZ33C1DD1 (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITIONS	SYMBOL	VALUE	UNIT			
Peak pulse current	Acc. IEC 61000-4-5, 8/20 μs/single shot	I _{PPM}	1.7	Α			
Peak pulse power	Acc. IEC 61000-4-5, 8/20 μs/single shot ⁽¹⁾	P _{PP}	100	W			
Peak pulse current	t _p = 10/1000 μs ⁽¹⁾	I _{PPM}	0.3	Α			
Peak pulse power	t _p = 10/1000 μs ⁽¹⁾	P _{PP}	15	W			
ECD insurant.	Contact discharge acc. IEC 61000-4-2; 10 pulses (1)	V	15	kV			
ESD immunity	Air discharge acc. IEC 61000-4-2; 10 pulses (1)	V_{ESD}	15	kV			
Operating temperature	Junction temperature	TJ	-55 to +150	°C			
Storage temperature		T _{stg}	-55 to +150	°C			

ELECTRICAL CHARACTERISTICS VMMBZ16C1DD1 (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITIONS / REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Protection paths	Number of lines which can be protected	N _{channel}	ı	-	1	lines	
Reverse stand off voltage	Max. reverse working voltage	V_{RWM}	-	-	14	V	
Reverse voltage	At I _R = 0.01 μA	V_R	14	-	-	V	
Davisias accument	At V _R = 14 V	I _R	-	< 0.001	0.01	μΑ	
Reverse current	At $V_R = 14 \text{ V}$; $T_J = 150 ^{\circ}\text{C}^{(1)}$		-	0.06	10	μΑ	
Davis and harmal adams well to an	At I _R = 1 mA	V_{BR}	16.2	16.7	17.3	V	
Reverse breakdown voltage	At $I_R = 1$ mA; $T_J = -40$ °C to $+150$ °C $^{(1)}$		15	-	18.7	V	
Reverse clamping voltage	At $I_{PP} = I_{PPM} = 4 \text{ A}$, $t_p = 8/20 \mu\text{s}$	V _C	20	23.7	27	V	
	$t_p = 100 \text{ ns (TLP)}; I_{TLP} = 16 \text{ A}^{(1)}$	V_{C_TLP}	-	26	-	V	
Dynamic resistance	t _p = 100 ns (TLP) ⁽¹⁾	r _{dyn}	=	0.55	=	Ω	
Capacitance	At $V_R = 0 V$; $f = 1 MHz$	C _D	12	14.5	17	pF	

ELECTRICAL CHARACTERISTICS VMMBZ33C1DD1 (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER TEST CONDITIONS / REMARKS		SYMBOL	MIN.	TYP.	MAX.	UNIT	
Protection paths	Number of lines which can be protected	N _{channel}	ı	-	1	lines	
Reverse stand off voltage	Max. reverse working voltage	V_{RWM}	-	-	28	V	
Reverse voltage	At I _R = 0.01 μA	V_{R}	28	-	-	V	
Reverse current	At V _R = 28 V	I _R	-	< 0.001	0.01	μA	
neverse current	At $V_R = 28 \text{ V}; T_J = 150 ^{\circ}\text{C}^{(1)}$		-	0.1	10	μA	
Reverse breakdown voltage	At I _R = 1 mA	V_{BR}	32.7	33.7	34.8	V	
heverse breakdown voltage	At $I_R = 1$ mA; $T_J = -40$ °C to $+150$ °C $^{(1)}$		30	-	39.7	V	
Reverse clamping voltage	At $I_{PP} = I_{PPM} = 1.7 \text{ A}$, $t_p = 8/20 \mu\text{s}$	V_{C}	40	49	59	V	
	$t_p = 100 \text{ ns (TLP)}; I_{TLP} = 16 \text{ A}^{(1)}$	V_{C_TLP}	-	88	-	V	
Dynamic resistance	$t_p = 100 \text{ ns (TLP)}^{(1)}$	r _{dyn}		3.3	ı	Ω	
Capacitance	At $V_R = 0 V$; $f = 1 MHz$	C_D	6	8	10	pF	

Note

⁽¹⁾ Guaranteed by design. Tested during device characterization

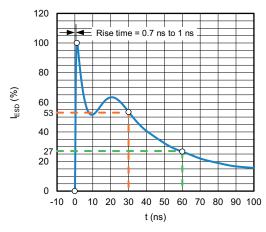


Fig. 1 - ESD Discharge Current Wave Form Acc. IEC 61000-4-2 (330 Ω / 150 pF)

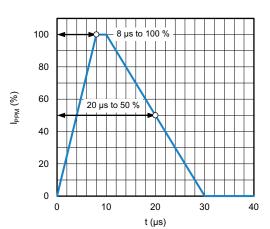


Fig. 2 - 8/20 µs Peak Pulse Current Wave Form Acc. IEC 61000-4-5

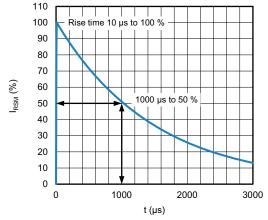


Fig. 3 - 10/1000 µs Peak Pulse Current Wave Form

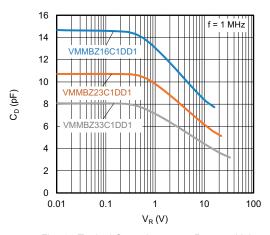


Fig. 4 - Typical Capacitance vs. Reverse Voltage

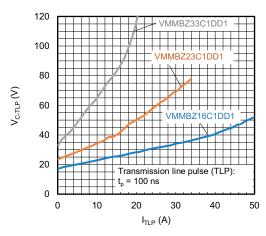


Fig. 5 - Typical Clamping Voltage vs. Peak Pulse Current

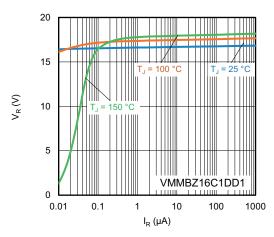


Fig. 6 - Typical Reverse Voltage vs. Reverse Current

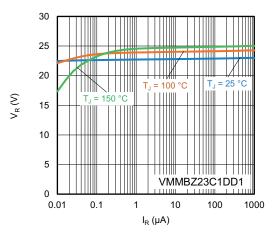


Fig. 7 - Typical Reverse Voltage vs. Reverse Current

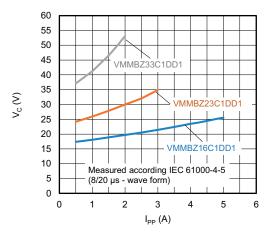


Fig. 8 - Typical Peak Clamping Voltage vs. Peak Pulse Current

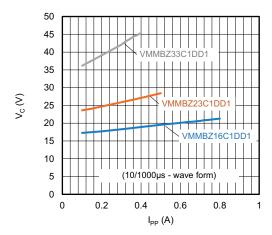
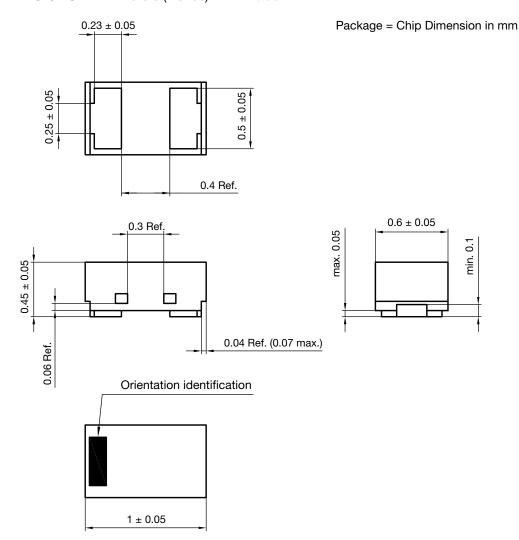


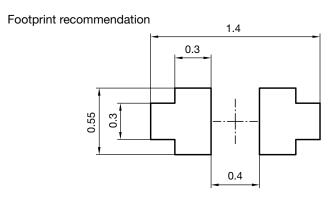
Fig. 9 - Typical Peak Clamping Voltage vs. Peak Pulse Current





PACKAGE DIMENSIONS in millimeters (inches): DFN1006-2B

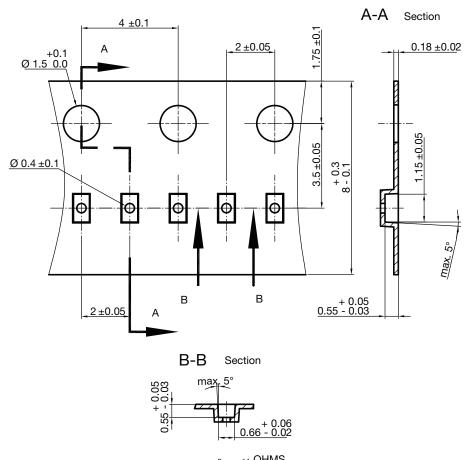




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CARRIER TAPE DFN1006-2B



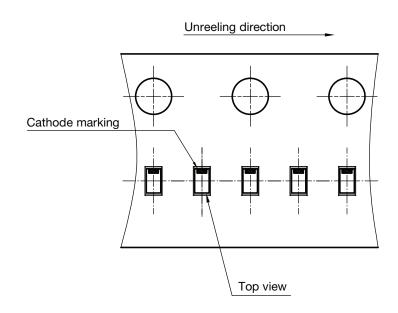
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S8-V-3906.04-064 (4)

created 28.10.2019

surface resistance: 10^5 - $10^{11} \frac{OHMS}{SQ}$ Cummulative tolerances of 10 sprocket holes is ± 0.2 mm

ORIENTATION IN CARRIER TAPE DFN1006-2B



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